



# PS7801M-1A

# 4-PIN ULTRA SMALL FLAT-LEAD, LOW C × R (3.4 pF • Ω) 1-ch Optical Coupled MOS FET

-NEPOC Series-

#### **DESCRIPTION**

The PS7801M-1A is a low output capacitance solid state relay containing a GaAs LED on the light emitting side (input side) and MOS FETs on the output side.

An ultra small flat-lead package has been provided which realizes a reduction in mounting area of about 50% compared with the PS72xx series.

It is suitable for high-frequency signal control, due to its low C  $\times$  R (3.4 pF  $\bullet$   $\Omega$ ), low output capacitance, and low off-state leakage current.

#### **FEATURES**

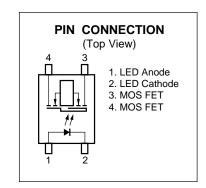
- Ultra small flat-lead package (4.2 (L) × 2.5 (W) × 1.85 (H) mm)
- Low C × R (C × R = 3.4 pF Ω)
- Low output capacitance (Cout = 0.95 pF TYP.)
- 1 channel type (1 a output)
- · Designed for AC/DC switching line changer
- Low offset voltage
- Ordering number of taping product: PS7801M-1A-F3: 3 500 pcs/reel
- · Pb-Free product
- Safety standards

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• UL approved: No. E72422

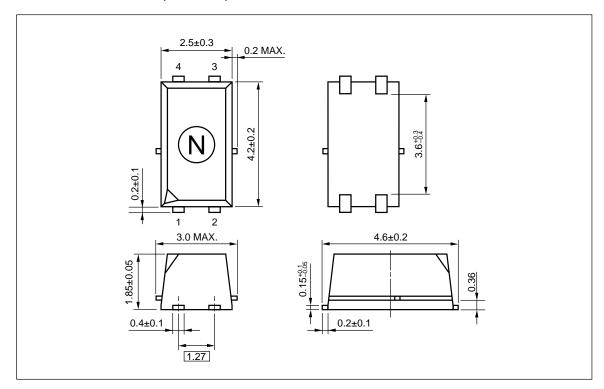
## **APPLICATIONS**

· Measurement equipment

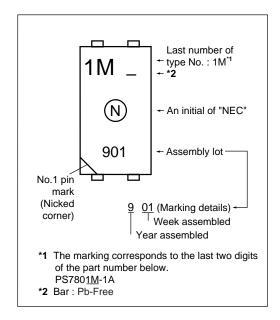


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## PACKAGE DIMENSIONS (UNIT: mm)



### <R> MARKING EXAMPLE



#### <R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS7801M-1A	PS7801M-1A-A	Pb-Free	50 pcs (Tape 50 pcs cut)	Standard products	PS7801M-1A
PS7801M-1A-F3	PS7801M-1A-F3-A		Embossed Tape 3 500 pcs/reel	(UL approved)	

<sup>\*1</sup> For the application of the Safety Standard, following part number should be used.

## ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	lF	50	mA
	Reverse Voltage	VR	5.0	V
	Power Dissipation	Po	50	mW
	Peak Forward Current*1	IFP	1	Α
MOS FET	Break Down Voltage	VL	20	V
	Continuous Load Current	lι	160	mA
	Pulse Load Current *2 (AC/DC Connection)	Ігь	240	mA
	Power Dissipation	Po	250	mW
Isolation Voltage*3		BV	500	Vr.m.s.
Total Power Dissipation		Рт	300	mW
Operating Ambient Temperature		TA	-40 to +85	°C
Storage Temperature		T <sub>stg</sub>	-40 to +100	°C

<sup>\*1</sup> PW = 100  $\mu$ s, Duty Cycle = 1%

## RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit	
LED Operating Current	lf	4.5	5	20	mA	
LED Off Current	lF	0.1			mA	

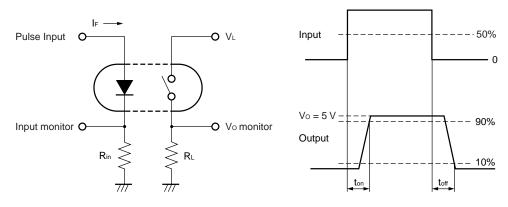
<sup>\*2</sup> PW = 100 ms, 1 shot

<sup>\*3</sup> AC voltage for 1 minute at  $T_A = 25^{\circ}$ C, RH = 60% between input and output. Pins 1-2 shorted together, 3-4 shorted together.

## **ELECTRICAL CHARACTERISTICS (TA = 25°C)**

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	I <sub>F</sub> = 5 mA		1.1	1.4	V
	Reverse Current	lr	V <sub>R</sub> = 5 V			5.0	μΑ
MOS FET	Off-state Leakage Current	Loff	V <sub>D</sub> = 20 V		0.03	0.25	nA
	Output Capacitance	Cout	$V_D = 0 \text{ V}, f = 1 \text{ MHz}, t \le 1 \text{ s}$		0.95	1.5	pF
Coupled	LED On-state Current	IFon	I <sub>L</sub> = 160 mA			4	mA
	On-state Resistance	Ron	$I_F = 5 \text{ mA}, I_L = 160 \text{ mA}, t \le 10 \text{ ms}$		3.6	5.0	Ω
	Turn-on Time*1, 2	ton	IF = 5 mA, Vo = 5 V, RL = 500 $\Omega$ ,		0.05	0.25	ms
	Turn-off Time*1, 2	<b>t</b> off	PW ≥ 0.5 ms		0.03	0.25	
	Isolation Resistance	R <sub>I-O</sub>	V <sub>I-O</sub> = 0.5 kV <sub>DC</sub>	10 <sup>9</sup>			Ω
	Isolation Capacitance	C <sub>I-O</sub>	V = 0 V, f = 1 MHz		0.3		pF

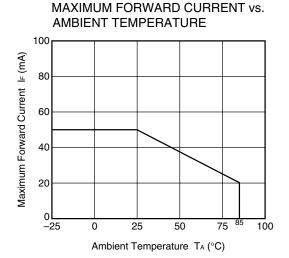
### \*1 Test Circuit for Switching Time

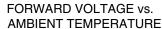


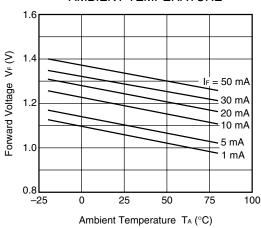
\*2 The turn-on time and turn-off time are specified as input-pulse width ≥ 0.5 ms.

Be aware that when the device operates with an input-pulse width less than 0.5 ms, the turn-on time and turn-off time will increase.

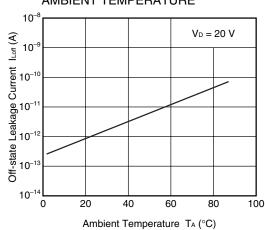
#### <R> TYPICAL CHARACTERISTICS (Ta = 25°C, unless otherwise specified)



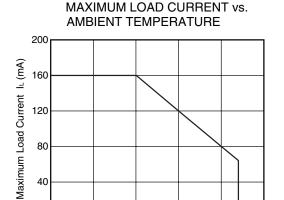




# OFF-STATE LEAKAGE CURRENT vs. AMBIENT TEMPERATURE



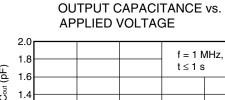
Remark The graphs indicate nominal characteristics.



Ambient Temperature T<sub>A</sub> (°C)

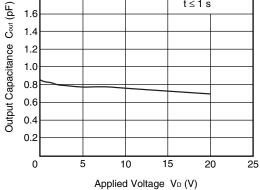
75

100

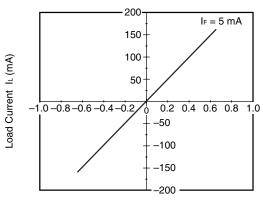


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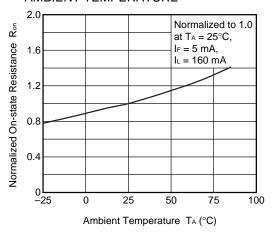


## LOAD CURRENT vs. LOAD VOLTAGE

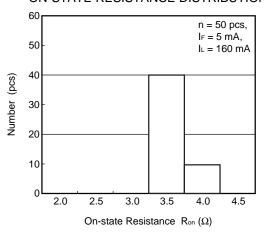


Load Voltage V<sub>L</sub> (V)

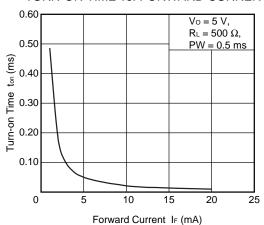
# NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



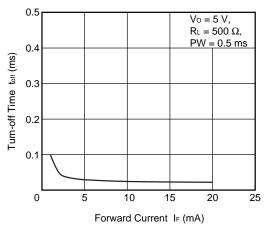
### ON-STATE RESISTANCE DISTRIBUTION



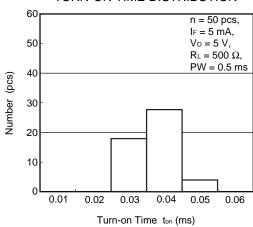
#### TURN-ON TIME vs. FORWARD CURRENT



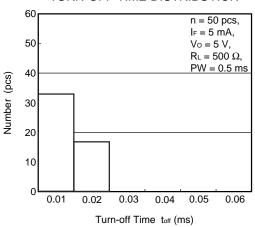
### TURN-OFF TIME vs. FORWARD CURRENT



### TURN-ON TIME DISTRIBUTION

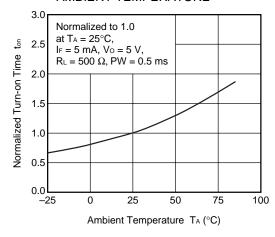


TURN-OFF TIME DISTRIBUTION



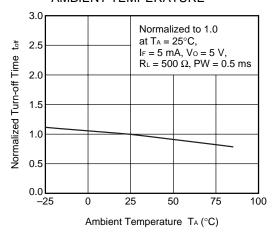
Remark The graphs indicate nominal characteristics.

# NORMALIZED TURN-ON TIME vs. AMBIENT TEMPERATURE

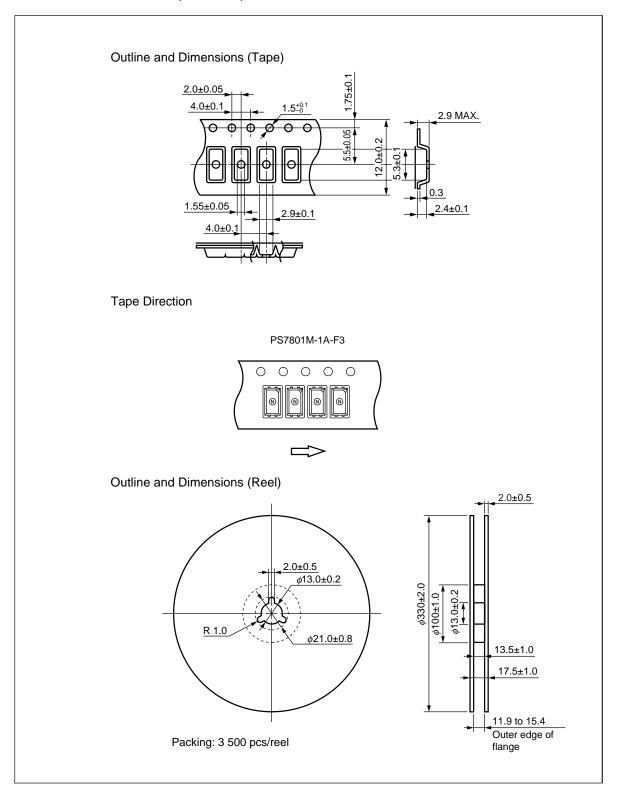


Remark The graphs indicate nominal characteristics.

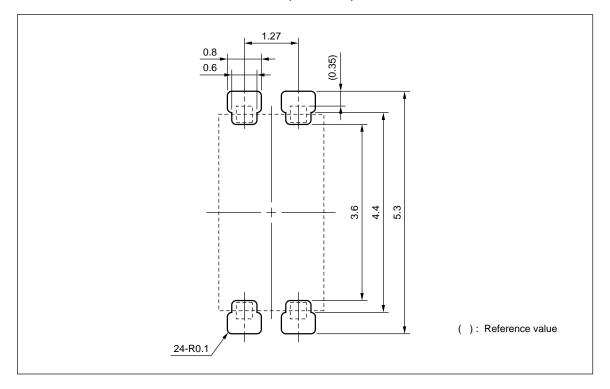
# NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE



## TAPING SPECIFICATIONS (UNIT: mm)



# RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



**Remark** All dimensions in this figure must be evaluated before use.

#### RECOMMENDED SOLDERING CONDITIONS

#### (1) Infrared reflow soldering

• Peak reflow temperature 260°C or below (package surface temperature)

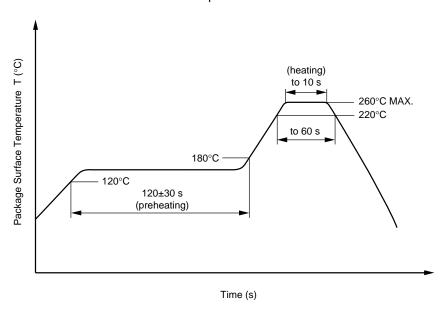
Time of peak reflow temperature
 Time of temperature higher than 220°C
 50 seconds or less
 60 seconds or less

Time to preheat temperature from 120 to 180°C 120±30 s
 Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



## (2) Wave soldering

Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

Preheating conditions 120°C or below (package surface temperature)

• Number of times One

Flux
 Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

#### (3) Soldering by soldering iron

Peak temperature (lead part temperature)
 Time (each pins)
 350°C or below
 3 seconds or less

Flux
 Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

#### (4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

10 Data Sheet PN10691EJ03V0DS

## **USAGE CAUTIONS**

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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#### Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
- Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.